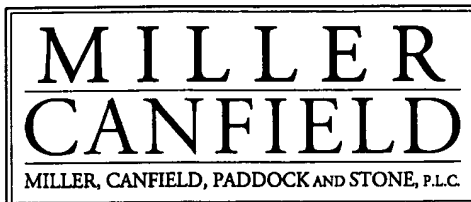


Founded in 1852  
by Sidney Davy Miller



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Katowice • Warsaw

**ROBERT KELLEY ROTH**  
TEL: (313) 496-7568  
FAX: (313) 496-8452  
E-MAIL: roth@millercanfield.com

150 West Jefferson, Suite 2500  
Detroit, Michigan 48226  
TEL: (313) 963-6420  
FAX: (313) 496-7500  
[www.millercanfield.com](http://www.millercanfield.com)

June 20, 2005



Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**Re: Serial No.: 10/730,580**  
**Inventors: Alan R. Pfaff, Jr.**  
**Our Reference No.: 123869-00001**  
**Title: Rotary Cutting Tool With Die Plate Position Adjustment**

Dear Sir:

Enclosed for filing please find:

- 1) Response to Notice of Non-Compliant Amendment regarding Office Action mailed on March 25, 2005;
- 2) Drawings (1 sheet); and
- 3) Certificate of Filing by Mailing.

We are also enclosing a post card receipt which we ask that you return to us acknowledging the date of receipt.

Very truly yours,

MILLER, CANFIELD, PADDOCK AND STONE, P.L.C.

By: \_\_\_\_\_

Robert K. Roth  
Reg. No. 36,660



MILLER, CANFIELD, PADDOCK AND STONE, P.L.C.

-2-

June 20, 2005

### CERTIFICATE OF FILING BY MAILING

This is to certify that the following documents were mailed by U.S. Postal Service First Class Mail to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 20, 2005.

- 1) Response to Notice of Non-Compliant Amendment regarding Office Action mailed on March 25, 2005;
- 2) Drawings (1 sheet); and
- 3) Certificate of Filing by Mailing.

MILLER, CANFIELD, PADDOCK AND STONE, P.L.C.

By: *Cheryl Triotti*  
Cheryl Triotti

DELIB:2632131.2\123869-00001



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
(123869.1)

Applicant: Alan R. Pfaff, Jr. Paper Number: 4  
U.S.S.N: 10/730,580 Art Unit: 3724  
Filing Date: 12/08/03 Examiner: Hamilton, I.  
Title: ROTARY CUTTING TOOL WITH DIE PLATE POSITION  
ADJUSTMENT

\*\*\*\*\*

Assistant Commissioner for Patents  
Washington, DC 20231

Sir:

The following is a Response to the First Office Action mailed on March 25, 2005  
in the above captioned patent application.

In the Drawings

Attached with the Response is a revised Fig. 1, moving lead line 14 to touch the  
die cylinder. No new matter has been added. Applicant respectfully requests entry of  
this revised Fig. 1.